

SSC8LA12GN6

N-Channel Enhanced MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
100V	1301/	3.6mR@10V	110A
	±20V	4.7mR@4V5	

Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. 100% UIS + DVDS Tested.

Applications

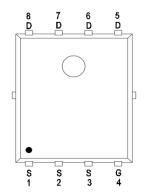
- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

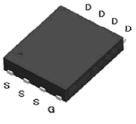
Ordering Information

Device	Package	Shipping
SSC8LA12GN6	PDFN5X6	5000/Reel

Pin configuration

Top view





PDFN5X6



Marking

(XX: product year / YY: product week)



➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit		
V_{DSS}	Drain-to-Source Vol	100	V		
V _{GSS}	Gate-to-Source Volt	Gate-to-Source Voltage		V	
	0 1 0 0 1 1	T _C =25°C	110		
l _D	Continuous Drain Current d	Tc=100°C	47	Α	
	Outine Dair Out 12	T _A =25°C	26		
I _{DSM}	Continuous Drain Current ^a	T _A =70°C	17	A	
I_{DM}	Pulsed Drain Curre	440	Α		
1	Power Dissipation °	Tc=25°C	74	14/	
P_D		Tc=100°C	30	W	
	B B: : :: a	T _A =25℃	4	10/	
P _{DSM}	Power Dissipation ^a	T _A =70°C	2.7	W	
las	Avalanche Current ^b L=0.5ml	45	Α		
Eas	Avalanche Energy b L=0.5mH Single Pulse		506	mJ	
TJ	Operation junction temp	-55~150	0.0		
T _{STG}	Storage temperature	-55~150	℃		

➤ Thermal Resistance Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{0JA}	Junction-to-Ambient Thermal Resistance ^a	30	°C/W
Rejc	R _{0JC} Junction-to-Case Thermal Resistance		C/ VV

Note:

- a. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A =25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t \leq 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

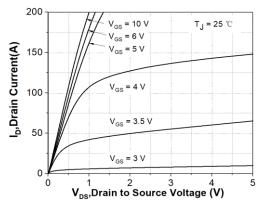


➤ Electronics Characteristics(T_A=25°C unless otherwise noted)

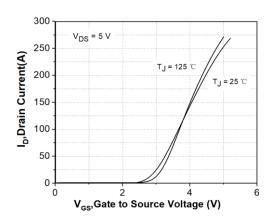
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V ,ID=250uA	100			V
V _{GS (th)}	Gate Threshold Voltage	VDS=VGS ,ID=250uA	1.2	2	2.4	V
	Drain-Source On-	VGS=10V , ID=30A		3.6	5	mR
R _{DS(on)}	Resistance	VGS=4.5V , ID=20A		4.7	7.5	IIIK
I _{DSS}	Zero Gate Voltage Drain Current	VDS=80V ,VGS=0V			1	uA
I _{GSS}	Gate-Source leak current	VGS=±20V ,VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=5V ,ID=20A		60		S
V _{SD}	Forward Voltage	VGS=0V , IS=20A		0.8	1.3	V
Rg	Gate Resistance	VDS=0V, f=1MHz		2.7		R
Ciss	Input Capacitance			4700		
Coss	Output Capacitance	VDS=50V , VGS=0V,		630		pF
Crss	Reverse Transfer Capacitance	f=1MHz		26		, pi
T _{D(ON)}	Turn-on delay time			20		
Tr	Rise time	VGS=10V, RL=2.5R		26		no
T _{D(OFF)}	Turn-off delay time	VDS=50V , RG=3R		65		ns
Tf	Fall time			70		
Q _G	Total Gate Charge	V00-40V VD0-50V		65		
QGS	Gate Source Charge	VGS=10V, VDS=50V		16		nC
Q _{GD}	Gate Drain Charge	- ID=20A		12		
Trr	Diode Recovery Time	IF=20A , di/dt=200A/us		50	_	ns
Qrr	Diode Recovery Charge	IF=20A , di/dt=200A/us		110		nC



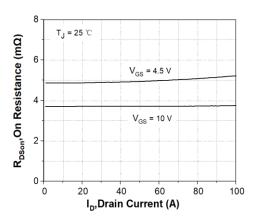
➤ Typical Characteristics(T_A=25°C unless otherwise noted)



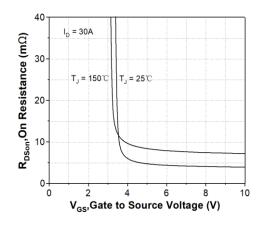
Output Characteristics



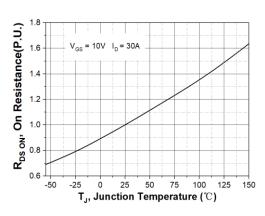
Transfer Characteristics



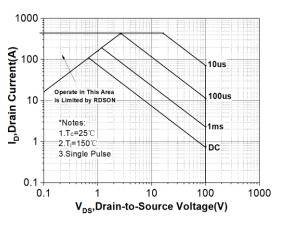
On-Resistance vs. Drain Current



On-Resistance vs. Gate-to-Source Voltage



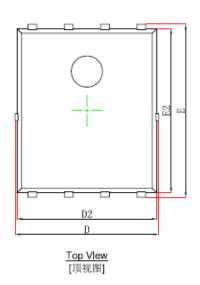
On-Resistance vs. Junction temperature

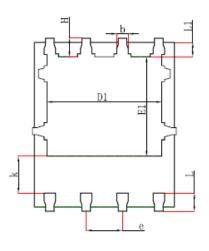


Safe Operating Area

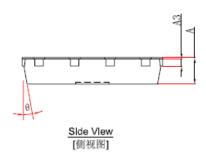


> Package Information





Bottom Vlew [背视图]



Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	IREF	0.010	0.010REF	
D	4.944	5.096	0.195	0.201	
Е	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270	TYP	0.050	OTYP	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	



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